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ICT Project No 688101 SUPERAID7

Stability Under Process Variability for Advanced Interconnects and Devices Beyond 7 nm Node

D6.1: Set-up of SUPERAID7 WWW Including Preliminary Version of Restricted Section

	Name	Organisation	Date
Edited	Eberhard Baer	Fraunhofer IISB	March 11, 2016



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Abstract

The structure and present contents of the SUPERAID7 WWW are described. The SUPERAID7 WWW aims at informing the public as well as at providing a means for exchange of information on different levels of confidentiality.

1. Introduction

The address of the homepage of the SUPERAID7 WWW is <u>www.superaid7.eu</u>. The webpage has been released in March 2016 and will be updated continuously.

The website contains a public section, a section for the partners, a section for the EC and the reviewers, and a section for the Industrial and Scientific Advisory Board (ISAB). Except for the public area, the sections are protected by accounts granting access to the respective authorized parties.

The technical implementation of the website is realized by a CQ5 content management system hosted by the central Fraunhofer IT services. This allows also straightforward extensions which might be necessary for instance to include further sub-sections.

2. Structure of SUPERAID7 WWW

The current sitemap of the SUPERAID7 WWW is shown in Figure 1.

2.1 Public Section

The public section is intended to display the goals and results of the project to the public. This is achieved for instance by providing a list of related publications, including also references to background work by the partners. Furthermore, the public deliverables and other suitable material such as public benchmarks will be part of the public section. A further section is devoted to the partners' software tools to be used in the SUPERAID7 software framework. The section "Events" informs about related events, for instance conferences with major involvement of one or more SUPERAID7 partners. A screenshot of the homepage which is the entry point for the public sections is shown in Figure 2.

2.2 Partners' Section

In the partners' section, material is provided which is intended for internal use within the consortium, such as presentations from partner meetings, information on papers in submission procedure, presentation or report templates, contact details of the project team members, etc.

2.3 Section for EC and Reviewers

This section contains the contractual documents (such as deliverables) and further official information to be shared between the consortium and the European Commission and reviewers.

2.4 Section for Industrial and Scientific Advisory Board (ISAB)

SUPERAID7 will allow selected companies and research institutes/universities to join the ISAB. Material from the project intended for the members of the ISAB will be available in this section.

Sitemap

HOME	
PROJECT IN FORMATION	
Pairtneirs	
Publications	
Softwa re	
EVENTS	
CONTACT	
PROTECTED SECTIONS	
Partners Section	
Team	
Meetings	
Docume nts	
EC Section	
ISAB Section	

Figure 1: Sitemap of the current status of the SUPERAID7 WWW.

Stability Under Process Variability for Advanced Interconnects and Devices Beyond 7 nm Node	→ Fraun hofe r-0	-> Fraun hofer-Gesells chaft 🖪			SITEMAP	
	HOME	PROJECT INFORMATION $~~$	EVENTS	CONTACT	protected sections \sim	
SUPERAID7 - St	ability Unde	er Process Variabili	tv for			
		nd Devices Beyond		ode		
	Among the physical lin	nitations which challenge progress in	nancelectronics	for		
	aggressively scaled Mor	re Moore, process variability is getting	ever more critical	. Effects		
	from various sources of process variations, both systematic and stochastic, influence each other and lead to variations of the electrical, thermal and mechanical behavior					
	of devices, interconnec		anu mechanicai p	enavior		
	-	ion (TCAD) offers the unique possibil itions and trace their effects on subse				
Levels of simulation addressed in SUPERAID 7	on devices and circuits	i.				
	Within SUPERAID 7 w	e will				
· · ·		pact of systematic and statistical proc				
- improve physical models and ex		7 nm node and below, including inte	rconnects,			
	tures such as TriGate/ΩG	Gate FETs or stacked nanowires, inclu	ding alternative cl	nannel		
materials.						
		from the European Union's Horizon 20	20 research and			
i n nova ti	on programme under gra	nt agree ment No 688101.				
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Figure 2: Screenshot of the SUPERAID7 homepage.